

2SC5390

Silicon NPN Epitaxial
High Frequency Amplifier

HITACHI

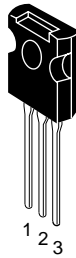
ADE-208-492 (Z)
1st. Edition
Dec. 1996

Features

- Excellent high frequency characteristics
 $f_T = 1.4\text{GHz}$ (typ.)
- Low output capacitance
 $C_{ob} = 2.4\text{ pF}$ (typ.)
- Isolated package
TO-126FM

Outline

TO-126FM



1. Emitter
2. Collector
3. Base

Absolute Maximum Ratings (Ta = 25°C)

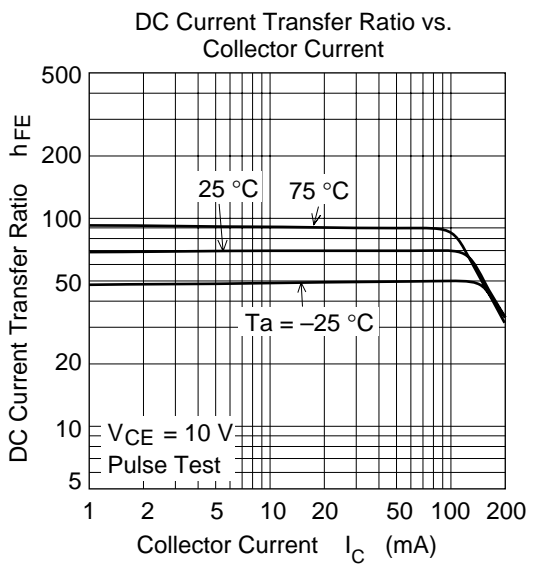
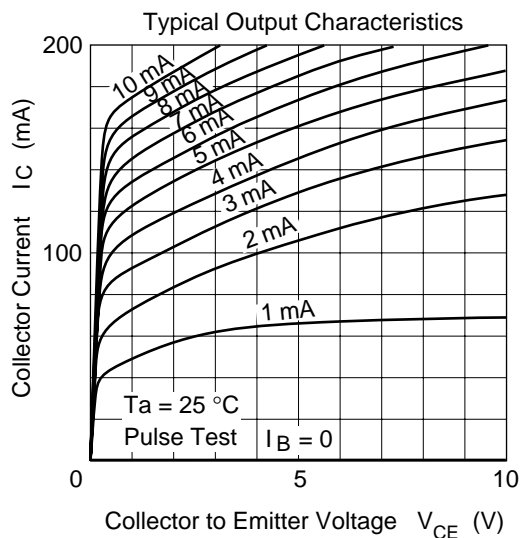
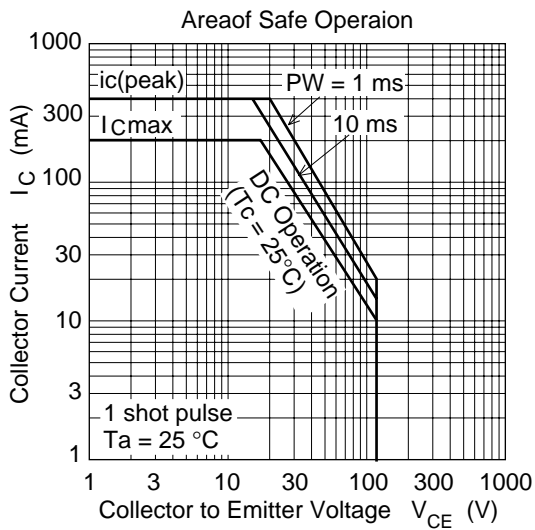
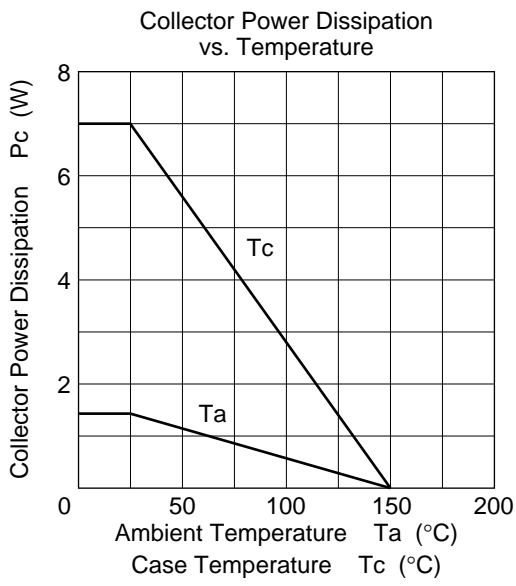
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	110	V
Collector to emitter voltage	V _{CEO}	110	V
Emitter to base voltage	V _{EBO}	3	V
Collector current	I _C	200	mA
Collector peak current	i _{c(peak)}	400	mA
Collector power dissipation	P _C	1.4	W
Collector power dissipation	P _C ^{*1}	7	W
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	−55 to +150	°C

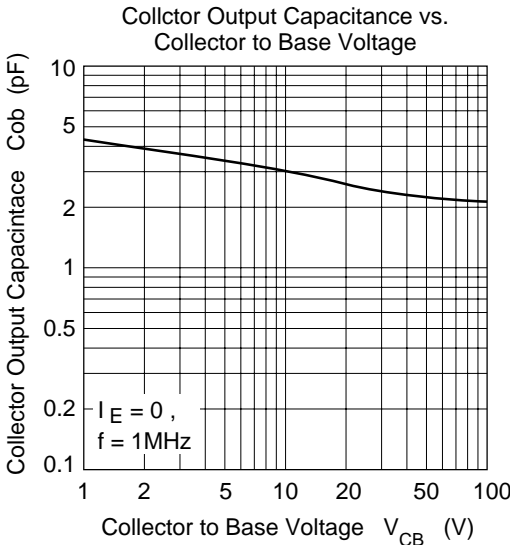
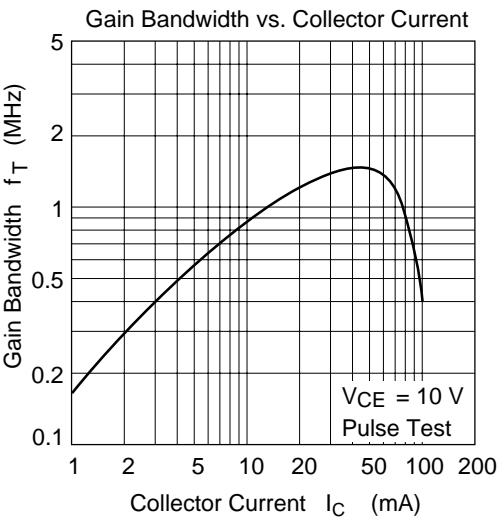
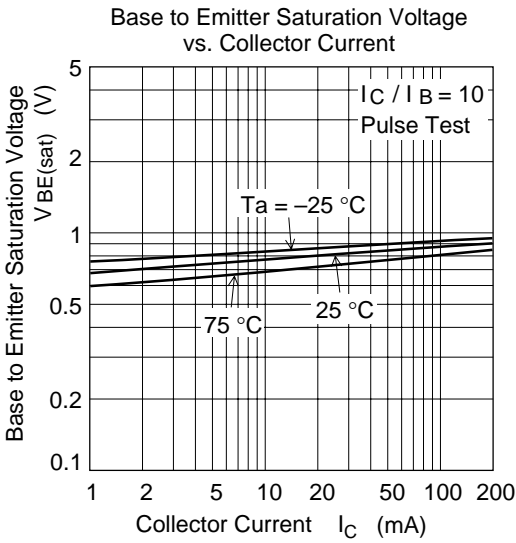
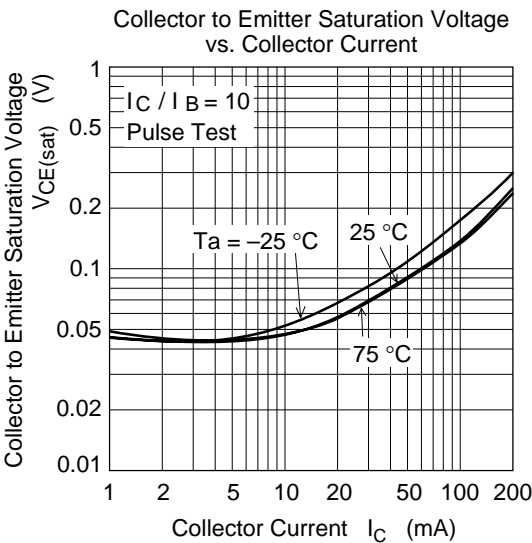
Note: 1. Value at Tc = 25°C

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Collector to base breakdown voltage	V _{(BR)CBO}	110	—	—	V	I _C = 10É A, I _E = 0
Collector to emitter breakdown voltage	V _{(BR)CEO}	110	—	—	V	I _C = 1mA, R _{BE} = ∞
Collector cutoff current	I _{CBO}	—	—	10	µA	V _{CB} = 100V, I _E = 0
Emitter cutoff current	I _{EBO}	—	—	10	µA	V _{EB} = 3V, I _C = 0
DC current transfer ratio	h _{FE}	30	—	100		V _{CE} = 10 V, I _C = 10mA
Base to emitter voltage	V _{BE}	—	—	1	V	V _{CE} = 10 V, I _C = 10mA
Collector to emitter saturation voltage	V _{CE(sat)}	—	—	1	V	I _C = 200mA, I _B = 20mA
Gain bandwidth product	f _T	1.0	1.4	—	GHz	V _{CE} = 10 V, I _C = 50mA
Collector Output capacitance	C _{ob}	—	2.4	3.5	pF	V _{CB} = 30V, I _E = 0 f = 1MHz

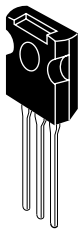
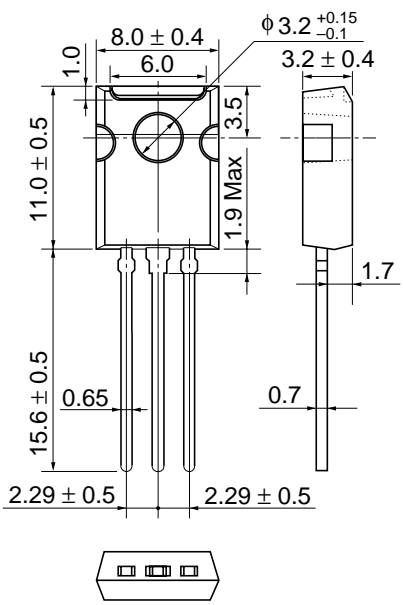
Main Characteristics





Package Dimintions

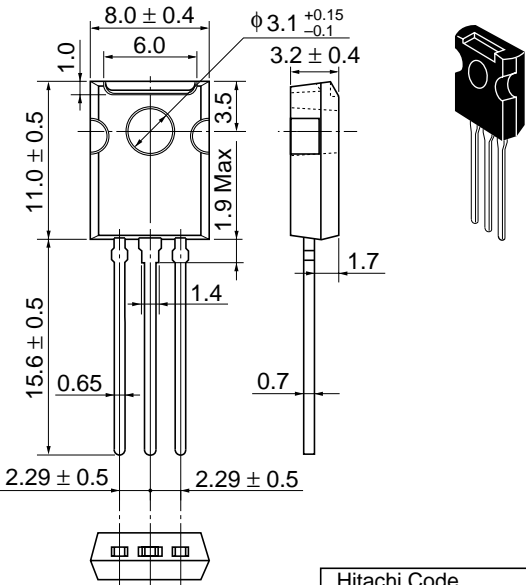
Unit: mm



Hitachi Code	TO-126FM
EIAJ	—
JEDEC	—

Package Dimensions

Unit: mm



Hitachi Code	TO-126FM
JEDEC	—
EIAJ	—
Mass (reference value)	0.87 g

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